

TANK-870-Q170

- High-Performance 6th/7th Generation Intel® Core™ Processor
- Fanless Embedded Computer

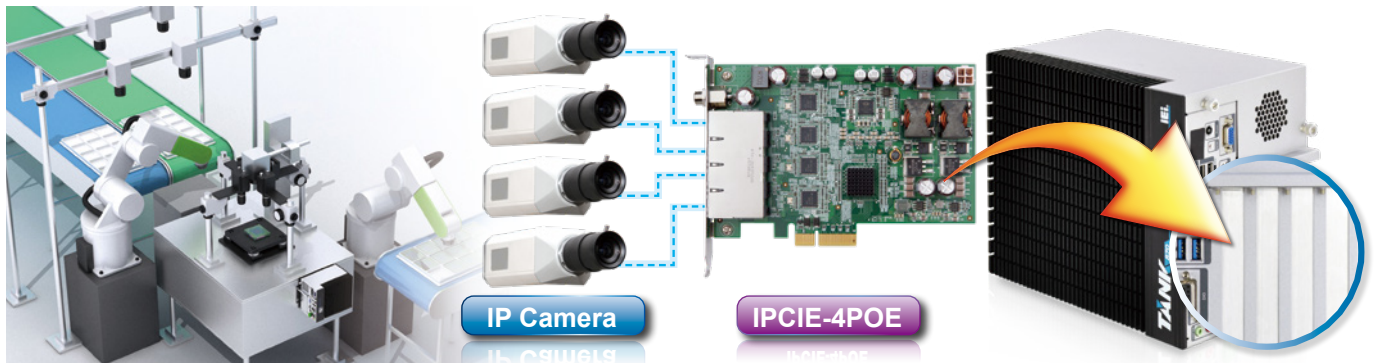
Features

- 6th/7th Gen Intel® Core™ processor platform with Intel® Q170 chipset and DDR4 memory
- Triple independent display with high resolution support
- Rich high-speed I/O interfaces on one side for easy installation
- On-board internal power connector for providing power to add-on cards
- Great flexibility for hardware expansion



Smart Choice for Surveillance System

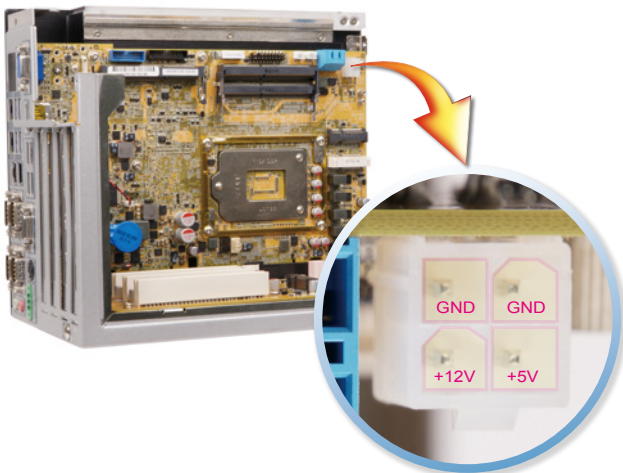
The TANK-870-Q170 integrated with IEI PoE Ethernet port expansion card can be used as a surveillance system for factory and public security. IEI PoE expansion card can support up to four PoE IEEE802.3af ports (max. 15.4 W per port) by PCIe x4.



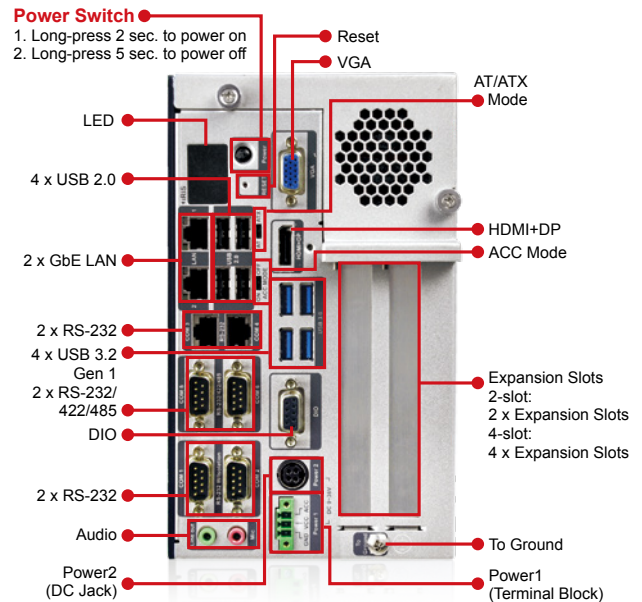
5V@3A or 12V@3A

Internal Power Connector

The TANK-870-Q170 provides the most convenient 4-pin internal power connector for add-on card usage, adding more flexibility to the embedded system in industrial environment.



Fully Integrated I/O



Flexible Expansion Interface

Backplane	TANK-870-Q170i-2A	TANK-870-Q170i-2B	TANK-870-Q170i-4A	
Slot Type	PCIe x16	PCIe x16	PCIe x16	PCIe x16
Signal	PCIe x8	PCIe x16	PCIe x8	PCIe x8
Slot Type	PCIe x16	PCI	PCI	PCI
Signal	PCIe x8	PCI	PCI	PCI
PCIe Mini	N/A	N/A	1	

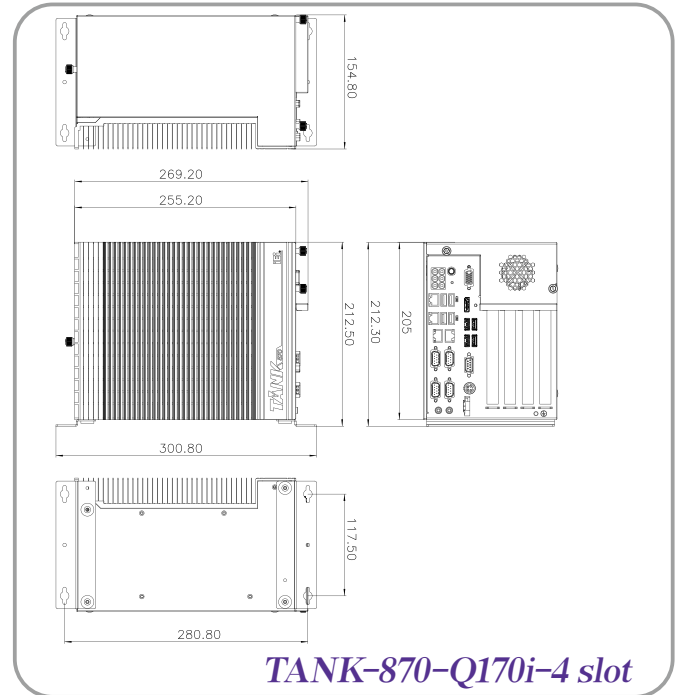
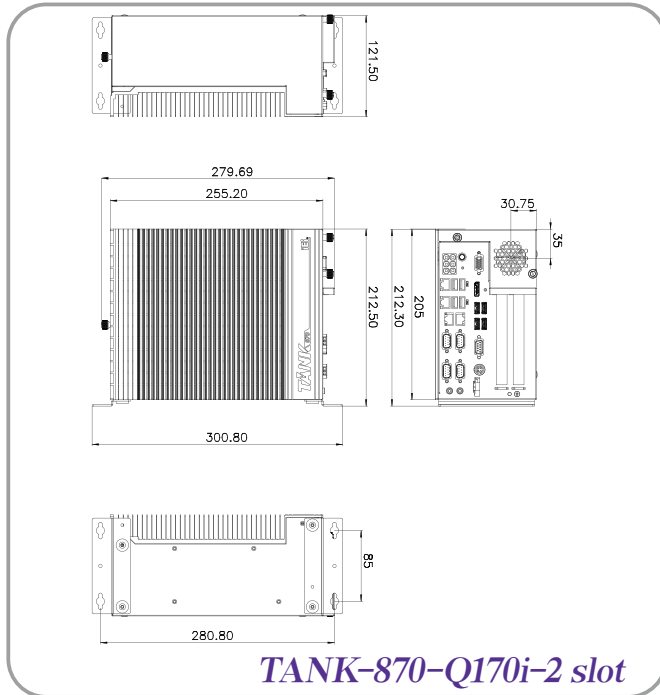
* The expansions described above are provided by the backplanes

Specifications

Model Name	TANK-870-Q170	
Chassis	Color	Black C + Silver
	Dimensions (WxDxH) (mm)	2-slot: 121.5 x 255.2 x 205 4-slot: 154.8 x 255.2 x 205
	System Fan	Fanless
	Chassis Construction	Extruded aluminum alloys
Motherboard	CPU	7 th Gen Intel® Core™ CPU & Intel® Core™ i7-6700TE 2.4 GHz (up to 3.4GHz, quad-core, TDP 35) Intel® Core™ i5-6500TE 2.3 GHz (up to 3.3GHz, quad-core, TDP 35)
	Chipset	Intel® Q170
	System Memory	2 x SO-DIMM DDR4 2133 (4GB pre-installed)(up to 32GB)
IPMI	iRIS Solution	1 x iRIS-2400 (optional)
Storage	Hard Drive	2 x 2.5" SATA 6Gb/s HDD/SSD bay (RAID 0/1 support)
I/O Interfaces	USB	4 x USB 3.2 Gen 1 4 x USB 2.0
	Ethernet	2 x RJ-45: LAN1: GbE by Intel® I219LM LAN2 (iRIS): GbE by Intel® I210
	COM Port	2 x RS-232/422/485 with AFC (DB-9) 4 x RS-232 (2 x RJ-45, 2 x DB-9 with 2.5kV isolation)
	Digital I/O	8-bit Digital I/O (4-in/ 4-out)
	Display	1 x VGA (up to 1920 x 1200@60Hz) 1 x HDMI/DP (up to 3840 x 2160@30Hz /4096 x 2304@60Hz) 1 x iDP (optional)
	Audio	1 x Line-out, 1 x Mic-in
	Wireless	1 x 802.11 a/b/g/n/ac (optional)
	TPM	1 x TPM 2.0 (2 x 10 pin) (optional)
Expansions	PCIe Mini	1 x Half-size (PCIe/ USB 2.0) 1 x Full-size (PCIe/ USB 2.0/ SATA)*
	Backplane	2-slot model: 1 x PCIe x16, 1 x PCI 2-slot model: 2 x PCIe x8 4-slot model: 2 x PCIe x8, 2 x PCI, 1 x Full-size PCIe Mini (PCIe/ USB 2.0)
Power	Power Input	DC Jack: 9 ~ 36V DC Terminal Block: 9 ~ 36V DC
	Power Consumption	19V@3.68A (Intel® Core™ i7-6700TE with 8 GB memory)
	Internal Power output	5V@3A or 12V@3A
Reliability	Mounting	Wall mount
	Operating Temperature	i7-6700TE: -20°C ~ 45°C with air flow (SSD), 10% ~ 95% non-condensing i5-6500TE: -20°C ~ 60°C with air flow (SSD), 10% ~ 95% non-condensing
	Storage Temperature	-40°C ~ 85°C with air flow (SSD), 10% ~ 90% non-condensing
	Operating Shock	Half-sine wave shock 5G, 11ms, 100 shocks per axis (SSD)
	Operating Vibration	MIL-STD-810G 514.6 C-1 (SSD)
	Weight (Net/Gross)	2-slot: 4.2 kg/6.3 kg 4-slot: 4.5 kg/6.5 kg
	Safety/EMC	CE/FCC/KC
OS	Supported OS	Microsoft® Windows® 8 Embedded, Microsoft® Windows® Embedded Standard 7 E, Microsoft® Windows® 10 IoT Enterprise

* TANK-870-Q170-QGW has no Full-size PCIe mini slot

Dimensions (Unit: mm)



Ordering Information

Part No.	Description
TANK-870-Q170i-i5/4G/2A-R11	Ruggedized fanless embedded system with Intel® Core™ i5-6500TE 2.3 GHz (up to 3.3 GHz, quad core, TDP 35W), 4GB DDR4 pre-installed memory, 2 x PCIe by 8 expansion, VGA/HDMI+DP/iDP, iRIS-2400 optional, 9 ~ 36V DC, RoHS
TANK-870-Q170i-i5/4G/2B-R11	Ruggedized fanless embedded system with Intel® Core™ i5-6500TE 2.3 GHz (up to 3.3 GHz, quad core, TDP 35W), 4GB DDR4 pre-installed memory, 1 x PCIe by 16 & 1 x PCI expansion, VGA/HDMI+DP/iDP, iRIS-2400 optional, 9 ~ 36V DC, RoHS
TANK-870-Q170i-i5/4G/4A-R11	Ruggedized fanless embedded system with Intel® Core™ i5-6500TE 2.3 GHz (up to 3.3 GHz, quad core, TDP 35W), 4GB DDR4 pre-installed memory, 2 x PCIe by 8 & 2 x PCI expansion, VGA/HDMI+DP/iDP, iRIS-2400 optional, 9 ~ 36V DC, RoHS
TANK-870-Q170i-i7/4G/2A-R11	Ruggedized fanless embedded system with Intel® Core™ i7-6700TE 2.4 GHz (up to 3.4 GHz, quad core, TDP 35W), 4GB DDR4 pre-installed memory, 2 x PCIe by 8 expansion, VGA/HDMI+DP/iDP, iRIS-2400 optional, 9 ~ 36V DC, RoHS
TANK-870-Q170i-i7/4G/2B-R11	Ruggedized fanless embedded system with Intel® Core™ i7-6700TE 2.4 GHz (up to 3.4 GHz, quad core, TDP 35W), 4GB DDR4 pre-installed memory, 1 x PCIe by 16 & 1 x PCI expansion, VGA/HDMI+DP/iDP, iRIS-2400 optional, 9 ~ 36V DC, RoHS
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Options

Part No.	Description
32000-000002-RS	European power cord
63040-010120-300-RS	Adapter Power;FSP;FSP120-AHAN3;9NA1206708;Active PFC;Vin:90 ~ 264VAC;120W;Dim:75.6*151.3*25.4mm;Plug=6.5mm;Cable=1500m m;Erp(NO LOAD 0.15W);Vout:12VDC;Din 4Pin/lock;CCL;RoHS
63040-010150-700-RS	Adapter Power;FSP;FSP150-ABAN3;9NA1504811;Active PFC;Vin:90 ~ 264VAC;150W;Dim:75.6*151.3*25.4mm;Plug=6.5mm;Cable=1500m m;Erp(NO LOAD 0.15W);Vout:19VDC;Din 4Pin/lock;CCL;RoHS
IRIS-2400-R10	IPMI 2.0 adapter card with AST2400 BMC chip for DDR3 SO-DIMM socket interface
EMB-FAN-KIT02-R10	Fan Module;MODIFY 31100-000272-RS;+12V DC;4PIN;40*40*15mm ;STANDARD;;FD124015LB2W3;; L= 400mm MOLEX 5051-04P P=2.54;CCL;RoHS
EMB-WIFI-KIT01-R20	1T1R wifi module kit for embedded system, IEEE802.11a/b/g/n/ac WiFi with Bluetooth 4.0/3.0+HS, 1 x wifi module, 2 x 250mm RF cable, 2 x Antenna, RoHS
DP-DP-R10	DisplayPort to DisplayPort converter board (for IEI IDP connector)
DP-HDMI-R10	DisplayPort to HDMI converter board (for IEI IDP connector)
DP-LVDS-R10	DisplayPort to 24-bit dual channel LVDS converter board (for IEI IDP connector)
DP-VGA-R10	DisplayPort to VGA converter board (for IEI IDP connector)
DP-DVI-R10	DisplayPort to DVI-D converter board (for IEI IDP connector)
IPICIE-4POE-R10	PCI Express Power over Ethernet frame grabber card, 4-port 1000 Base(T), 802.3af compliant, RoHS
TANK-870-Q170-WES7E64-R10	OS Image with Windows® Embedded Standard 7 E 64-bit for TANK-870-Q170 Series, with DVD-ROM, RoHS
TANK-870-Q170-W10E64-H-R10	OS Image with Windows® Embedded Standard 10 E High End 64-bit for TANK-870-Q170-i7 Series, with DVD-ROM, RoHS
TANK-870-Q170-W10E64-V-R10	OS Image with Windows® Embedded Standard 10 E Value 64-bit for TANK-870-Q170-i5 Series, with DVD-ROM, RoHS
TPM-IN02-R20	20-pin Infineon TPM2.0 module, software mangement tool, firmware v5.5

* The TANK-870 can support up to 40°C operating temperature when installing with the IPICIE-4POE-R10.

Packing List

1 x Chassis Screw	1 x Mounting Bracket	2 x RJ45 to COM Port Cable
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